

ROUND COPPER



SOLDERABLE COPPER	S.H 180
Thermal class	180°C
Nature of the isolation	Base Coat: Polyurethane
Diameter	Φ 0.112 - 2.00mm
Grade	G-1, G-2
Colour	Natural, red, green
Breakdown voltage	≥ 1.5 x IEC
Heat shock	> 175°C
Solderability	390°C 3 sec.
Cut through	≥ 250°C
Chemical resistance	Good
Standard	IEC 60317-51 MW 82-C IEC-851 (Testing methods)
Certifications	UL: 327951 & 93551 ISO TS 16949 ISO 9001:2000
Description	Cu S.H 180 "Diameter" G-"Grade"
Options	There is an option of ordering with a polyamide overcoat (no UL), produced under IEC-60317-55 and MW 80 C and identified as SOLD+NYL.
Applications	Micro motors (home appliances), relays. Automatic and connection without striping processes, contactors, transformers, magnetic coils.